



2822

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By: 

Date: February 10, 2003

9/A Andt  
2-25-03  
A. Wall

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Matthias Stecher et al.  
Applic. No. : 10/073,847  
Filed : February 11, 2002  
Title : SOI Component  
Examiner : Mark V. Prenty  
Group Art Unit : 2822

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A M E N D M E N T

Hon. Commissioner of Patents and Trademarks,  
Washington, D. C. 20231

S i r :

Responsive to the Office action dated November 8, 2002 kindly  
amend the above-identified application as follows:

In the Claims:

Claim 1 (amended). A semiconductor component, comprising:

a semiconductor substrate;

11/18/03